



DUAL P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

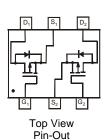
BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
	150mΩ @ V _{GS} = -4.5V	-1.8A
-20V	200mΩ @ V _{GS} = -2.5V	-1.6A
	240mΩ @ V _{GS} = -1.8V	-1.4A

Description

This new generation MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- General Purpose Interfacing Switch
- Power Management Functions





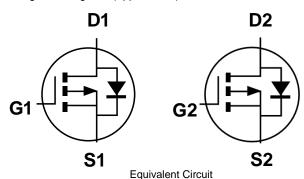
Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP2110UVTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish—Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ©3
- Weight: 0.013 grams (Approximate)



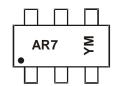
Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2110UVTQ-7	TSOT26	3000/Tape & Reel
DMP2110UVTQ-13	TSOT26	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



AR7 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Date Code Rey												
Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	G	Н	I	J	K	L	M	N	0	Р	R	S
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V _{DSS}	-20	V
Gate-Source Voltage		V _{GSS}	±10	V
Drain Current (Note 5) Continuous	T _A = +25°C T _A = +70°C	ID	-1.8 -1.4	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	-15	Α
Body-Diode Continuous Current (Note 5)		Is	-0.7	Α

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P_{D}	0.74	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	168	°C/W
Total Power Dissipation (Note 6)		PD	1.01	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	ReJA	124	°C/W
Operating and Storage Temperature Range	•	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 7)								
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	V _G S = 0V, I _D = -250μA		
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	-1.0	μΑ	V _{DS} = -16V, V _{GS} = 0V		
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 7)								
Gate Threshold Voltage	V _{GS(TH)}	-0.45	_	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		
			_	150		$V_{GS} = -4.5V$, $I_{D} = -2.8A$		
Static Drain-Source On-Resistance	R _{DS(ON)}	_	_	200	mΩ	$V_{GS} = -2.5V$, $I_{D} = -2.0A$		
	, ,		_	240		$V_{GS} = -1.8V, I_D = -1.0A$		
Diode Forward Voltage	VsD	_	_	-1.0	V	V _G S = 0V, I _S = -1A		
DYNAMIC CHARACTERISTICS (Note 8)					•			
Input Capacitance	Ciss	_	443	_	pF	., ., ., .,		
Output Capacitance	Coss	_	59	_	pF	$V_{DS} = -6V, V_{GS} = 0V$ - f = 1.0MHz		
Reverse Transfer Capacitance	Crss	_	47	_	pF	-1 = 1.0WH2		
Gate Resistance	Rg	_	8.5	_	Ω	V _G S = 0V, V _D S = 0V, f = 1.0MHz		
Total Gate Charge	Qg	_	6.0	_	nC			
Gate-Source Charge	Qgs	_	0.6	_	nC	V _G S = -4.5V, V _D S = -10V, I _D = -3A		
Gate-Drain Charge	Q _{qd}	_	1.8	_	nC	7		
Turn-On Delay Time	tD(ON)	_	4.0	_	ns			
Turn-On Rise Time	t _R	_	3.7	_	ns	V _{DS} = -10V, V _{GS} = -4.5V,		
Turn-Off Delay Time	t _{D(OFF)}	_	24.5	_	ns	$R_L = 10\Omega, R_G = 1.0\Omega, I_D = -1A$		
Turn-Off Fall Time	tF	_	9.5	_	ns	1		
Reverse Recovery Time	trr	_	8.3	_	ns	IF = -1.0A, di/dt = 100A/µs		
Reverse Recovery Charge	Q _{RR}	_	2.0	_	nC	I _F = -1.0A, di/dt = 100A/μs		

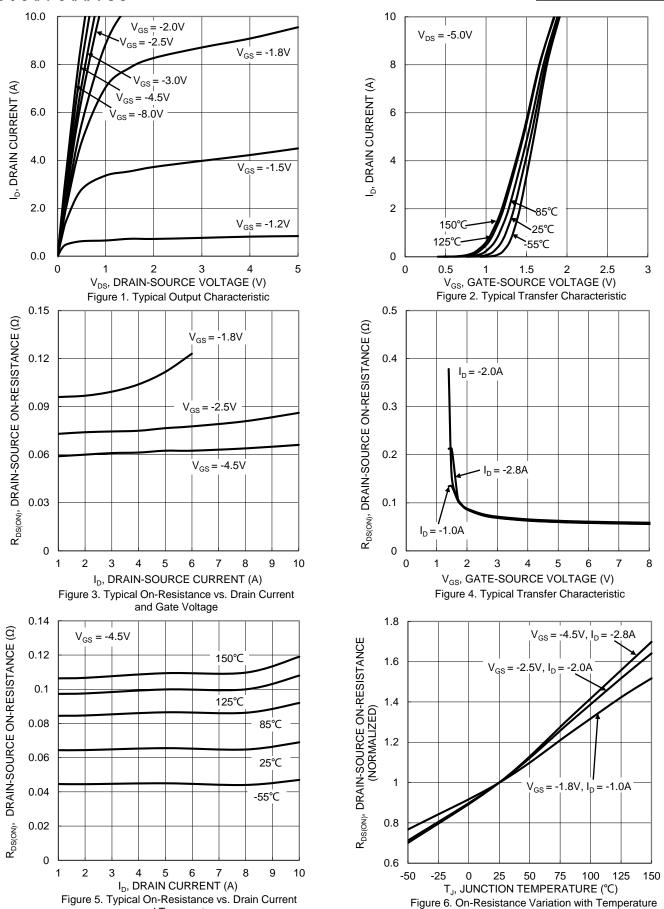
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.





and Temperature



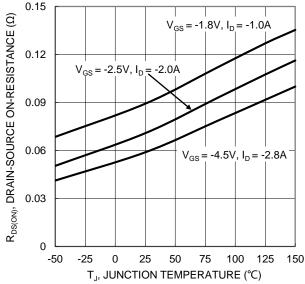


Figure 7. On-Resistance Variation with Temperature

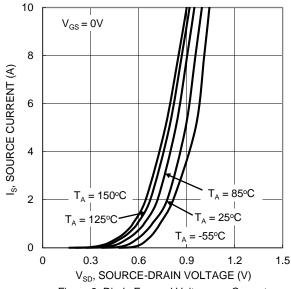
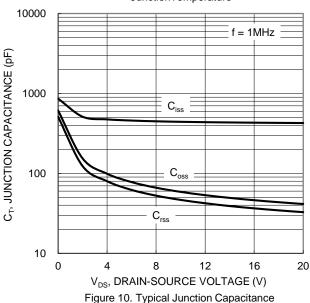


Figure 9. Diode Forward Voltage vs. Current 10 8 6 V_{GS} (V) 4 $V_{DS} = -10V, I_{D} = -3.0A$ 2 0 0 2 8 10 12 14 Q_q (nC) Figure 11. Gate Charge

1.2 $V_{GS(TH)}$, GATE THRESHOLD VOLTAGE (V) 1 8.0 $I_D = -1mA$ 0.6 $I_D = -250 \mu A$ 0.4 0.2 0 -25 0 25 50 75 125 -50 100 150 T_J, JUNCTION TEMPERATURE (°C)

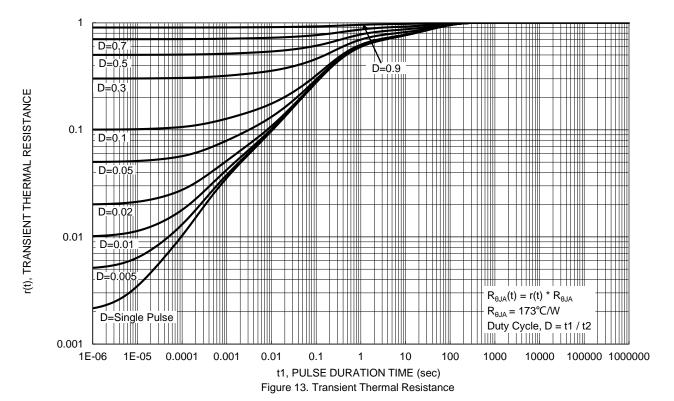
Figure 8. Gate Threshold Variation vs. JunctionTemperature



100 R_{DS(ON)} Limited 1ms 10 ID, DRAIN CURRENT (A) $T_{J(Max)} = 150^{\circ}C$ $T_C = 25^{\circ}C$ Single Pulse DUT on 1*MRP P_W = Board DC $V_{GS} = -4.5V$ 0.01 10 0.1 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V)

Figure 12. SOA, Safe Operation Area



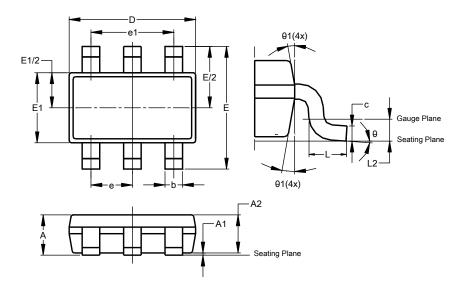




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26

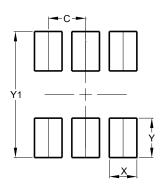


TSOT26						
Dim	Min	Max	Тур			
Α	1	1.00	-			
A1	0.010	0.100	-			
A2	0.840	0.900	_			
D	2.800	3.000	2.900			
Е	2	.800 BS	С			
E1	1.500	1.700	1.600			
q	0.300	0.450	-			
O	0.120	0.200	-			
е	0.950 BSC					
e1	1	.900 BS	С			
Г	0.30	0.50	-			
L2	0.250 BSC					
θ	0°	0° 8°				
θ1	4°	12°	-			
Α	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.200



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DMP2110UVTQ 7 of 7
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